



Docket No.: 300.1144

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Hideaki SAKAGUCHI, et al.

Serial No. 10/757,498

Group Art Unit: 1756

Confirmation No. 4627

Filed: January 15, 2004

Examiner: Kathleen Duda

For: METHOD FOR DICING WAFER

AMENDMENT

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

This is in response to the Office Action mailed July 18, 2006, and having a period for response set to expire on October 18, 2006.

The following amendments and remarks are respectfully submitted. Reconsideration of the claims is respectfully requested.